

Industry Linkage and academic Alliance

Date- 31/08/2021

Venue: Online

Subject: Virtual Education Fair

Participants: All engineering students from FE/SE/TE/BE. There were total 232 students participants and 38 students from E&TC.

Activity Name: Edfair

Objective:

1. To create a platform for the students where they can have one to one interaction with delegated of Universities of U.S.A.
2. To resolve student's doubt about course selection and future of course.
3. To make students aware about documents preparation for admission in foreign university.

Universities involved in fair:

Delegates from various universities were invited to provide guide lines about admission procedure, courses in respective university, opportunities of funds and availability of education loans.

Following are the universities visited to TCET:

1. University of Illinois Urban-Champaign
2. Clemson University
3. University of Texas at Arlington
4. University of Cincinnati
5. San Jose State University
6. University of Illinois at Chicago
7. San Diego State University
8. Victoria University, Melbourne
9. Pace University
10. Western New England University
11. University of Colorado Denver
12. James Cook University
13. University of Massachusetts Lowell
14. Oklahoma State University
15. Florida Polytechnic University
16. New Jersey Institute of Technology
17. University of South Florida
18. Arizona State University
19. Binghamton University
20. University of North Texas